

FQD3P50 P-Channel QFET[®] MOSFET - 500 V, - 2.1 A, 4.9 Ω

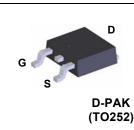
Description

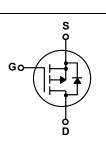
This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

May 2015

Features

- 2.1 A, 500 V, ${\sf R}_{\sf DS(on)}$ = 4.9 Ω (Max.) @ ${\sf V}_{\sf GS}$ = 10 V, ID = 1.05 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 9.5 pF)
- 100% Avalanche Tested





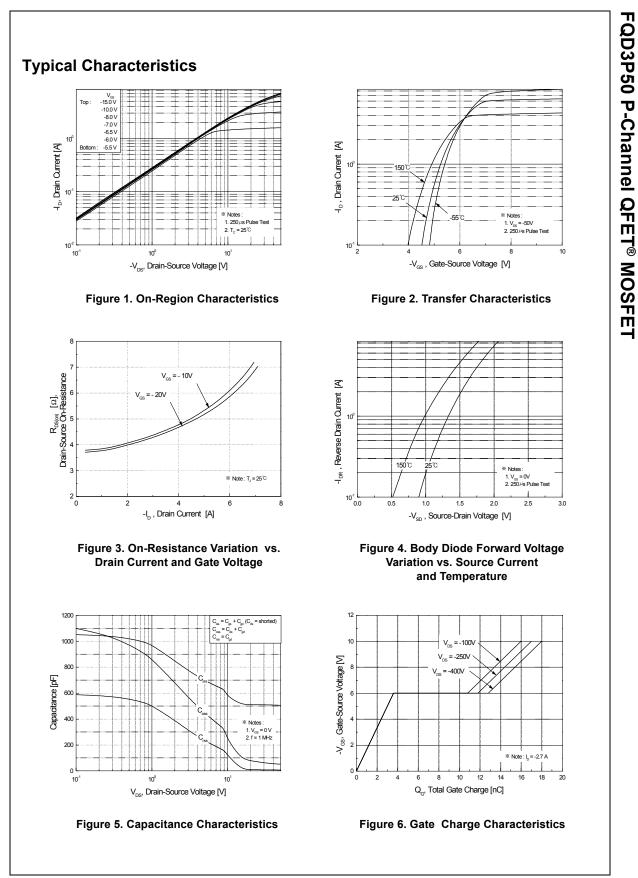
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQD3P50	Unit
V _{DSS}	Drain-Source Voltage		-500	V
ID	Drain Current - Continuous (T _C = 25	°C)	-2.1	A
	- Continuous (T _C = 100°C)		-1.33	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-8.4	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	250	mJ
I _{AR}	Avalanche Current	(Note 1)	-2.1	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *		2.5	W
	Power Dissipation (T _C = 25°C)		50	W
	- Derate above 25°C		0.4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Ra	-55 to +150	°C	
TL	Maximum lead temperature for soldering 1/8" from case for 5 seconds	300	°C	

Thermal Characteristics

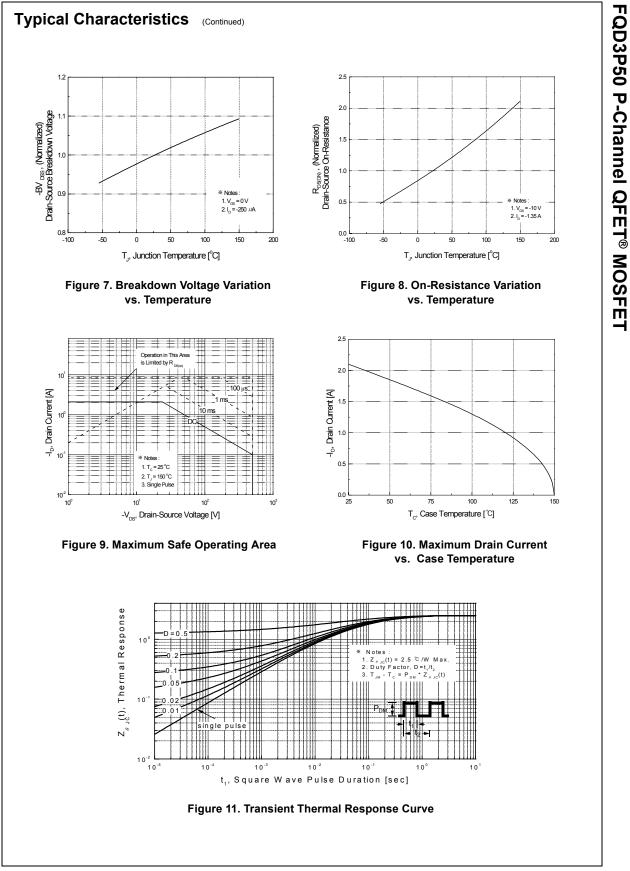
Symbol	Parameter	FQD3P50	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max. *	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	°C/W

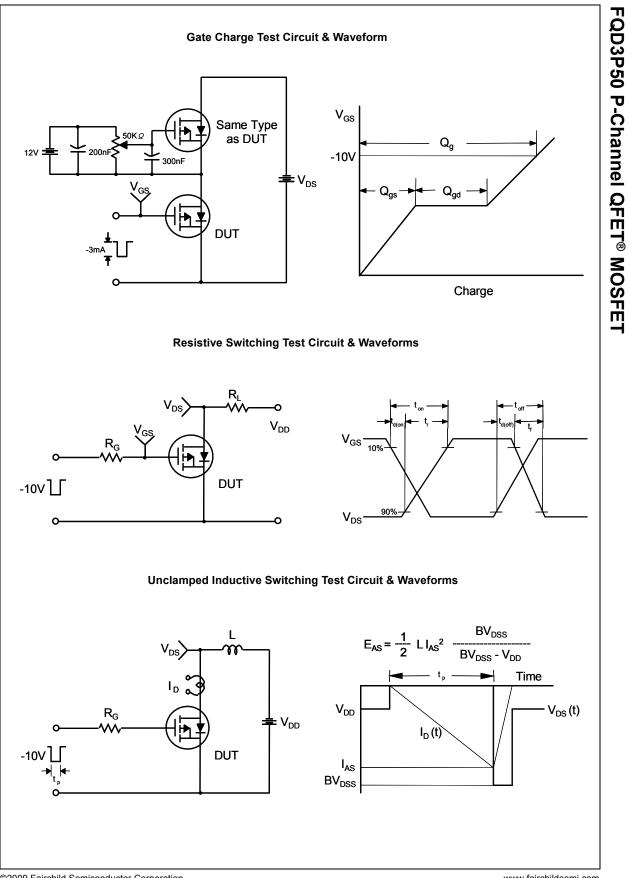
	Parameter	Test Conditions	Min	Тур	Мах	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage $V_{GS} = 0 \text{ V}, \text{ I}_D = -250 \mu\text{A}$		-500			V
ΔBV _{DSS}	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		0.42		V/°C
I _{DSS}		V _{DS} = -500 V, V _{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -400 V, T _C = 125°C			-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_{D} = -250 \ \mu A$	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.05 A		3.9	4.9	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -50 V, I _D = -1.05 A		2.1		S
D						
Dynami C _{iss}	ic Characteristics Input Capacitance			510	660	pF
C _{oss}	Output Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$		70	90	pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		9.5	12	pF
d(on)	Turn-On Delay Time Turn-On Rise Time	V_{DD} = -250 V, I _D = -2.7 A, R _G = 25 Ω		12 56	35 120	ns ns
u(011) t _r						
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off Fall Time	(Note 4)		45	100	ns
Qg	Total Gate Charge	V _{DS} = -400 V, I _D = -2.7 A,		18	23	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		3.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		9.2		nC
Drain-S	ource Diode Characteristics an Maximum Continuous Drain-Source Dio	•			-2.1	A
	Maximum Pulsed Drain-Source Diode F	Forward Current			-8.4	Α
I _{SM}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.1 A			-5.0	V
I _{SM} V _{SD}	Dialit-Source Dioue Forward Voltage	00 - 70				
	Reverse Recovery Time	$V_{GS} = 0 V, I_S = -2.7 A,$		270		ns



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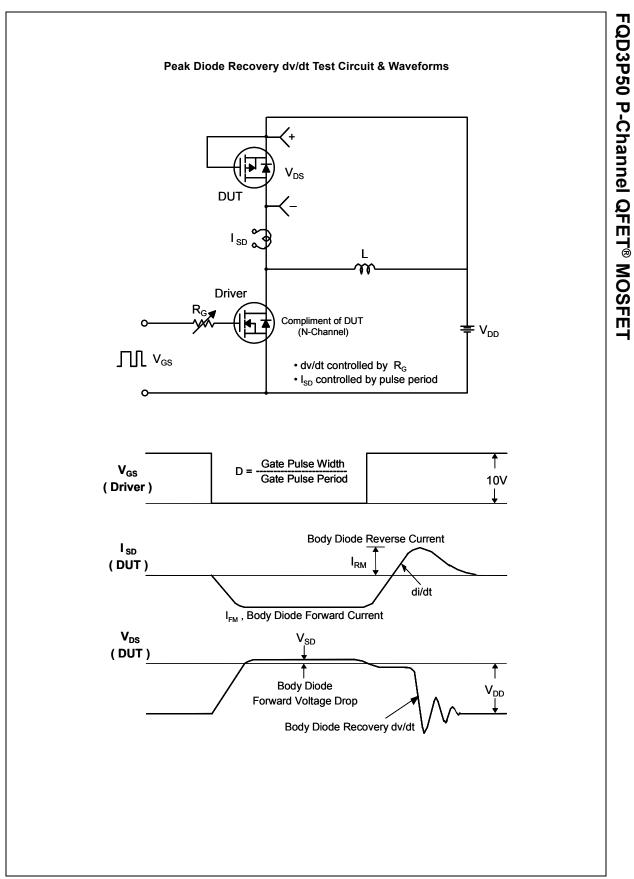
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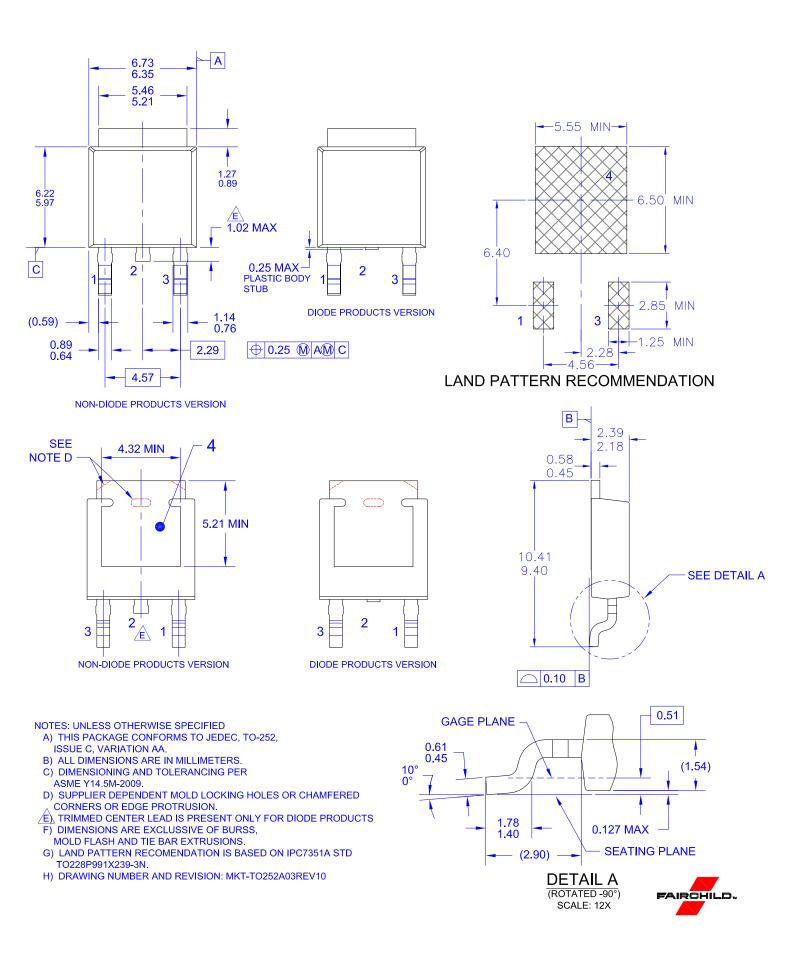




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